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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

KIAN TENG ENG ET AL.

Serial No. 09/766,477 (TI-22944.2)

Filed January 19, 2001

For: VERTICAL BALL GRID ARRAY INTEGRATED CIRCUIT PACKAGE

Art Unit 2827

Examiner James M. Mitchell

Commissioner for Patents
Washington, D. C. 20231

Sir:

AMENDMENT UNDER 37 C.F.R. 1.111

In response to the Office action dated August 18, 2003, please amend the above identified application as follows: